imall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832 Email & Skype: info@chipsmall.com Web: www.chipsmall.com Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China

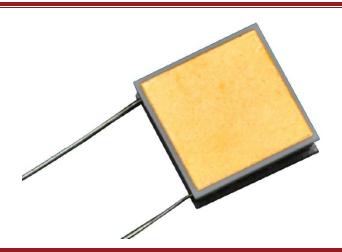


MARLOW MATERIALS THAT MATTER



Technical Data Sheet for NL1012T

Single-Stage Thermoelectric Module



NOMINAL PERFORMANCE IN NITROGEN

Hot Side Temperature (°C)	27	50
Δ Tmax (°C):	61	68
Qmax (watts):	2.1	2.4
Imax (amps):	1.0	1.0
Vmax (vdc):	3.7	4.2
AC Resistance (ohms):	3.24	
Device ZT	0.77	

PRODUCT FEATURES

- RoHS EU Compliant
- Ceramic Material: Aluminum Oxide
- Maximum process temperature is 120°C.
- 01AC, -02AC, -04AC: Metallized Exterior Surfaces are Au flash, suitable for soldering.
- -04AC: Height dimension includes metallization and excludes solder.

ORDERING OPTIONS

Model Number	Description
NL1012T-01AC	TEM, Top and Base Metallized
NLIUIZI-UIAC	Exterior
NL1012T-02AC	TEM, Base Metallized Exterior
NL1012T-03AC	TEM, No Metallized Exterior
NL1012T-04AC	TEM, Top and Base Pre-Tinned with
	117°C Solder.

OPERATION CAUTIONS

For maximum reliability, storage and operation below 100°C in a non-condensing environment is recommended. To minimize thermal stress when operating in cooling mode, use linear/proportional temperature control or a similar method rather than an ON/OFF method.

INSTALLATION

Recommended mounting methods: Bonding with thermal epoxy or soldering with metallized ceramics. For additional information, please refer to our TEC Installation Guide.

II-VI Marlow – Dallas, TX USA 214-340-4900 877-627-5691 marlow.sales@ii-vi.com Marlow Industries Europe GmbH - Germany +49 (0) 6150 5439 - 403 info@marlow-europe.eu II-VI Japan Inc. 81 43 297 2693 (tel) center@ii-vi.co.jp www.ii-vi.co.jp II-VI Singapore Pte., Ltd. (65) 6481 8215 (tel) info@ii-vi.com.sg Marlow Industries China, II-VI Technologies Beijing 86-10-643 98226 info@iivibj.com

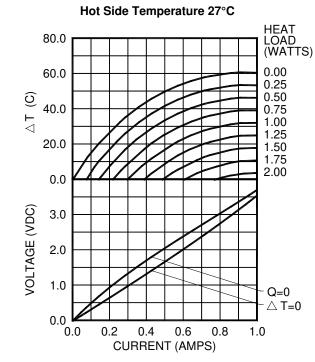
www.marlow.com

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ENVIRONMENT: ONE ATMOSPHERE DRY NITROGEN



POWER GENERATION PERFORMANCE CURVES

40 45 50 55

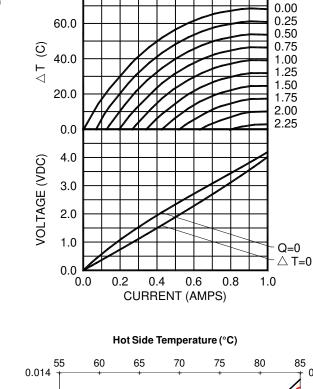
Hot Side Temperature (°C)

65

75

Efficiency

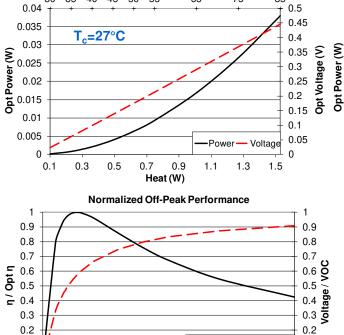
85



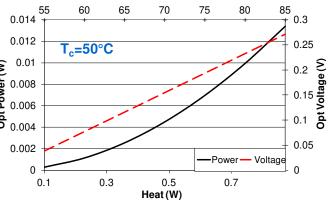
Hot Side Temperature 50°C

HEAT LOAD

(WATTS)



Load Resistance Ratio



85	55	35
27	27	27
2.52	1.28	0.37
0.038	0.009	0.001
0.446	0.213	0.060
5.23	4.88	4.65
0.78	0.37	0.11
0.20	0.10	0.03
38.51	38.56	38.50
	27 2.52 0.038 0.446 5.23 0.78 0.20	27 27 2.52 1.28 0.038 0.009 0.446 0.213 5.23 4.88 0.78 0.37 0.20 0.10

For performance information in a vacuum or with hot side temperatures other than 27°C or 50°C, contact one of our Applications Engineers at 877-627-5691.

0.1

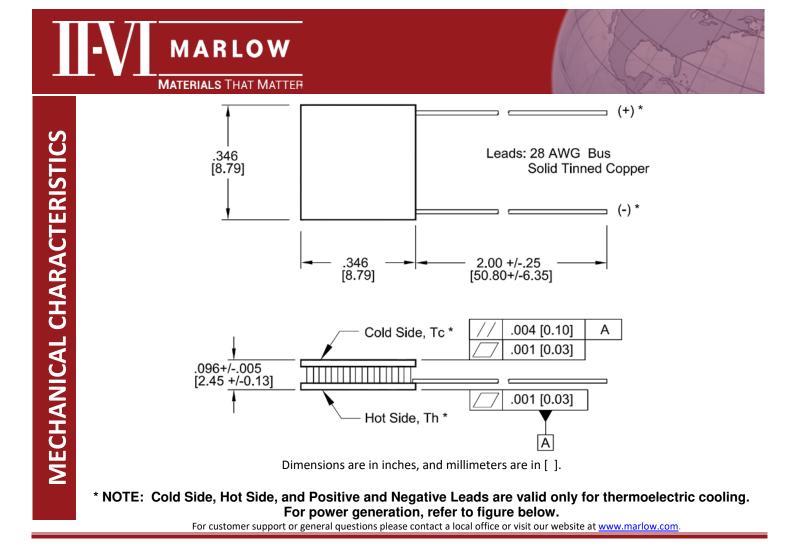
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Voltage

30 35

0.1

0 1 2 3 4 5 6 7 8 9 10



Power Generation performance information is given in a nitrogen environment and cold side temperatures of 27°C and 50°C. Module temperature does not include thermal resistance of heat sinks. For performance information in vacuum, other cold side temperatures, or specific heat sinks, consult one of our applications engineers.

TYPICAL POWER GENERATION CONFIGURATION

